Status of the ATLAS Pixel Detector at the LHC and its performance after three years of operation

PIXEL2012
Inawashiro – 3-7 September 2012
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Università di Milano and INFN
for the ATLAS Collaboration.

With special thanks to P. Morettini, K. Lantsch and B. Di Girolamo
• The ATLAS Detector at the LHC
• The Pixel Detector
• In situ calibrations and performance
• Status and operation in 2012
  – Operational efficiency
  – Radiation effects on silicon and electronics
• Tracking performances
• Summary and perspectives

Some preview of the posters:
• Track and vertex reconstruction in the ATLAS Inner Detector
• Monitoring radiation damage in the ATLAS Pixel Detector
• Neural network based cluster creation in the ATLAS silicon Pixel Detector
A Toroidal LHC Apparatus

Muon Detectors
Tile Calorimeter
Liquid Argon Calorimeter

Toroid Magnets
Solenoid Magnet
SCT Tracker
Pixel Detector
TRT Tracker

25 m
45 m
Three level trigger system:
• Level 1, hardware
  • 2.5 µs latency
• Level 2 + Event Filter, software
• Prescales adjusted according to instantaneous beam conditions
• Sustained output rate up to 400 Hz

![Trigger flow diagram](image)
Running conditions

- LHC is performing extremely well
  - Luminosity $> 7 \times 10^{33} \text{ cm}^{-2}\text{s}^{-1}$ almost at its design value.
  - Bunch spacing at 50 ns $\Rightarrow$ a lot of pile-up!
ATLAS Inner Detector

- Composite tracking system:
  - Transition Radiation Tracker
  - Silicon Strips: 80 µm pitch/stereo
  - Silicon Pixels: 50 µm × 400 µm
- 2 T solenoidal magnetic field
- Track reconstruction:
  - Acceptance $|\eta|<2.5$ ($|\eta|<2$ for TRT)
  - Reconstruction possible down to $p_T \approx 100$ MeV

See Kenji Hamano's poster for ATLAS tracking performance
The ATLAS Pixel Detector

- **Three barrel layers:**
  - $R = 5$ cm (B-Layer), 9 cm (Layer-1), 12 cm (Layer-2)
  - modules tilted by 20° in the $R\phi$ plane to overcompensate the Lorentz angle.

- **Two endcaps:**
  - three disks each
  - 48 modules/disk

- **Three precise measurement points up to $|\eta| < 2.5$:**
  - $R\phi$ resolution: 10 $\mu$m
  - $\eta$ (R or z) resolution: 115 $\mu$m
  - 1456 barrel modules and 288 forward modules, for a total of 80 million channels and a sensitive area of 1.7 m$^2$.

- Environmental temperature about -13 °C
Module overview

- **Sensor**
  - 47232 n-on-n pixels with moderated p-spray insulation
  - 250 µm thickness
  - 50 µm (RΦ) x 400 µm (η)
  - 328 rows ($x_{local}$) x 144 columns ($y_{local}$)

- **16 FE chips**
  - bump bonded to sensor

- **Flex Hybrid**
  - passive components
  - Module Controller Chip to perform distribution of commands and event building.

- **Radiation-hard design:**
  - Dose 500 kGy
  - NIEL $10^{15}$ n$_{eq}$/cm$^2$ fluence

5 years at $10^{34}$ cm$^{-2}$s$^{-1}$
The Pixel Detector FE cell:
- a constant (adjustable) feedback current pre-amp
- a discriminator with 7 bit DAC to adjust threshold
- circuitry to measure **Time over Threshold** (ToT)
- analog and digital injection points for calibration

End of Column:
- storage of hits during the Level-1 trigger latency time
- 64 memory buffers for each column pair of $2 \times 160$ pixels
- pixel ID + timestamp + ToT
A module is connected to the external world via a low mass cable providing all the required services:

- Bias: HV + analog and digital LV
- Temperature measurement
- Clock, serial command and data output lines

Data connection between on- and off-detector readout electronics is through an optical link.

Each link can be tuned by setting:

- signal phase
- threshold
Calibration procedures

Given the enormous number of channels and free parameters to tune, the read-out electronics and the DAQ software were designed with particular attention to the calibration procedures.

Using the **internal front-end electronics self-test and charge injection capabilities**:  

1. **Tune the custom rad-hard opto-link parameters** to guarantee error free data transmission.

2. **Adjust the discriminator threshold of each channel** to minimize threshold dispersion.

3. **Measure the noise** of each channel.

4. **Tune the time-over-threshold**.
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- Threshold and noise are determined by measuring the discriminator response as a function of the injected charge.
- The **Pixel Detector** is operated at \(3500 \text{ e}^{-}\) threshold, with a dispersion of few tens of electrons.
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- The typical **noise** of normal size pixels is **below 200 e.**

- The **large signal over noise ratio** guarantee a good stability margin even for the pixels at the edge of the array. A lower threshold (2000 e or even below) could be used if needed.
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4. **Tune the time-over-threshold.**

- The pixel read-out cell can measure (in 25 ns units) the time the discriminator input remains over threshold. This is correlated with the **deposited charge**.
- The pixel cell pre-amp feedback current can be adjusted to equalize the ToT response.
• The occupancy due to noise can be calculated from the noise measured with the charge injection, or derived directly with a random trigger.
• The agreement between the two methods is good and the occupancy per pixel/BC is below $\sim 10^{-9}$, masking less than 0.02% of the pixels.
• The hit efficiency of each silicon layer can be measured performing a track fit without that layer and looking for hits aligned with the resultant tracks. Typical hit inefficiencies are of the order of 0.2% (excluding the effect of dead modules).
• The Pixel Detector is the primary tool for selecting primary vs. secondary particles (converted photons for example) and suppressing fake tracks.
Detector status in 2012

- Currently **77 non operable modules** (out of 1744, i.e. 4.4%)
- In **2008**, after the installation, we had **25 non operable modules**. So, in average, we have a failure increase of 0.6-0.7% per year. Outermost layer seems to be more fragile.
- Failures are highly correlated with cooling stops. We tried to reduce the thermal shock whenever possible.
- Not always possible to identify the exact reason for the malfunctioning. Most common failures are **broken wire-bonds** or **dark optical links**.
- **Very stable operation**: fully efficient D(A)Q

### Module failures by layer

- **L2 6.7%**
- **B 3.1%**
- **Layer 1 2.0%**
- **Layer 2 6.7%**
- **Disk A**

### Module failures by type

- **HV**
- **LV**
- **Dead Optoboard**
- **Dark channel**
- **Clock missing**
- **Unable to configure**
- **Unable to tune opto**
- **Data taking failures**

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**ATLAS p-p run: April-June 2012**

<table>
<thead>
<tr>
<th>Inner Tracker</th>
<th>Calorimeters</th>
<th>Muon Spectrometer</th>
<th>Magnets</th>
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<td>TRT</td>
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<tr>
<td></td>
<td>Toroid</td>
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**All good for physics: 93.6%**

Luminosity weighted relative detector uptime and good quality data delivery during 2012 stable beams in pp collisions at \(\sqrt{s}\) TeV between April 4th and June 18th (in %) – corresponding to 6.3 fb\(^{-1}\) of recorded data. The inefficiencies in the LAr calorimeter will partially be recovered in the future.
Many elements in the read-out chain, and, in particular conditions, each buffer or link can be saturated.

The MCC/ROD link is a weak element, especially for the outermost layer which is connected at 40 Mb/s.

The end of column buffers will saturate at pixel occupancies around $1.6 \times 10^{-3}$. 

Attilio Andreazza, ATLAS Pixel Detector

PIXEL2012 – 3 September 2012
Occupancy extrapolation

The Pixel Detector is now operating in a very reliable way at $7 \times 10^{33} \text{cm}^{-2}\text{s}^{-1} @ 50 \text{ ns}$. But after the shutdown LHC luminosity will increase. Extrapolations of the expected occupancies due to minimum bias are done for 3 LHC luminosities: $1$, $2$ and $3 \times 10^{34} \text{cm}^{-2}\text{s}^{-1} @ 25 \text{ ns}$ (2015-2017).

For the 2015-2017 points we assume (13) $14 \text{ TeV}$, so the occupancies are scaled up by 20% to take into account the increase in minimum bias cross section. We can see that today’s occupancy is larger than the one expected at design luminosity. But even at 3 times the design luminosity, the occupancy looks tolerable for the read-out system.
Facing high luminosities

• The Pixel Detector was designed for $10^{34}\text{cm}^{-2}\text{s}^{-1}$, but extrapolations of the present running conditions indicate the it can be operated at 2-3 $10^{34}\text{cm}^{-2}\text{s}^{-1}$.

• We are continuously improving our procedures to maximize data taking efficiency and minimize the risk of permanent damage.

• **Specific tuning** (e.g. higher threshold or faster shaping time) could be beneficial at high luminosity (possibility to reduce the load on the read-out system at the expense of the track quality).

• One aspect that is potentially dangerous as the luminosity increases is the effect of SEU, that are clearly visible even now. For example, we observe an increased rate in module desynchronizations at the beginning of each LHC fill. We are exploiting all the capabilities of the read-out electronics to detect and correct these effects in real-time.

![Synchronization errors vs run time](image)
Radiation damage

• The sensors of the ATLAS Pixel Detector were designed to be still operational after a fluence of $10^{15} \text{n}_{\text{eq}}/\text{cm}^2$.
• That would correspond to $\sim 300 \text{ fb}^{-1}$ of integrated luminosity for the innermost layer.
• Today, at $\sim 15 \text{ fb}^{-1}$, the detector is still in its infancy...

• But effects are starting to be measurable:
  – Increase of leakage current
  – Depletion voltage

See Andree Schorlemmer’s poster for more details about radiation damage
Leakage current measurements

Three available tools:

1. With the **power supply**, per group of 6/7 modules, with a precision of \(\sim 80 \text{ nA}\).

2. For a single module, with **dedicated hardware**. The precision is \(\sim 10 \text{ nA}\), available for a limited number of modules.

3. At the **pixel level**, with a specific feature implemented in the FE chip. Useful in particular to **map non homogeneous current distributions**.

The three methods agree well, and clearly show the **increase with luminosity and the effect of the annealing**.

*Predictions based on the “Dortmund” model (O. Krasel) underestimate the data by 15-25%.*
Depletion voltage measurement

• Before type-inversion, can be measured looking at the **pixel cross-talk during a voltage scan**, as the undepleted region creates a resistive path.
  
  – Number of pixels showing cross-talk hits decreases with increasing HV
  
  – Sensor structures are visible near full depletion.

• The **depletion voltage decreases with the accumulated dose**, as we are about type-inversion for the innermost layer.

• The **annealing effect** due to cooling stops is clearly visible.

• The **depletion depth can also be measured off-line**, correlating the track incidence angle with the cluster size.
Position reconstruction

• If particles leave signal in more than one pixel, **the point resolution can be improved**, with respect to a simple geometric center of cluster, **using the pulse height** measurements.

• Classical approach:
  – Charge sharing variables:
    \[
    \Omega_x = \frac{Q_{\text{last row}}}{Q_{\text{first row}} + Q_{\text{last row}}} \quad \Omega_y = \frac{Q_{\text{last column}}}{Q_{\text{first column}} + Q_{\text{last column}}}
    \]
  – Cluster position correction:
    \[
    (x_c, y_c) \rightarrow \left[ x_c + \Delta_x \left( \Omega_x - 1/2 \right), y_c + \Delta_y \left( \Omega_y - 1/2 \right) \right]
    \]

• Cluster may assume complex structures:
  – Ovelapping particles, in high density environments (core of jets)
  – δ-ray production or hadronic interactions
  – Need to fully exploit the detector information.

See the neural network reconstruction poster for more details about position resolution
Neural network processing

• A neural network is used to process the full cluster shape:
  – Recognizes hits from multiple particles
  – Non-linear interpolation of charge distribution.

• Trained on simulation of high density events:
  – $t\bar{t}$
  – High $p_T$-jets

• Very significant improvement in performance:
  – Recover tails in cluster position.
  – Reduced by an order of magnitude the ambiguities in cluster-to-track association
  – Recovery of tails and improved association efficiency results in 15% improvement in impact parameter resolution.
Impact parameter resolution

- Impact parameter is used to discriminate primary from secondary particles.
- Key ingredient in the reconstruction of heavy flavours ($b$, $c$, $\tau$)
- Resolution is dominated by the first measurement on track.
  - At high $p$, intrinsic detector resolution and alignment.  
    10 µm resolution in barrel region
  - At low $p$, detector material.  
    Material effects extremely well described.
Summary and perspectives

The performance of the ATLAS Pixel Detector has been extremely satisfactory in the first years of LHC data taking:

- Meeting or **even exceeding** design specifications.
- Since the very beginning of data taking (with cosmic rays in 2008), the detector has been operating in a stable and smooth way, delivering high quality data.
- Coping well with the increasing occupancy and luminosity by a steady improvements of DAQ, calibration and data reconstruction.
- Radiation effects are observable, but matching expectations.

We expect the detector to operate well during the whole LHC phase 1, i.e. up to 2017. Some improvement is however needed…

Preparing for the next steps during the 2013-2014 LHC shutdown

- See Ole’s talk for the status of the 4th layer of the ATLAS Pixel Detector (IBL).
- The extraction of the detector for the installation of new service panels is under study:
  - Allows the recovery of some dead modules.
  - Improves the performance at high luminosity.
• For ganged pixels, the spacing in the inter-chip region and in the chip-edge regions are different: for multiple-pixel clusters it is possible to disentangle in which region it was generated.
Mass determination inverting Bethe-Bloch energy loss relation

~12% dE/dx resolution
Hadro-graphy

- Material mapping usually performed by photon conversions

- Hadronic interactions can reach a better position resolution:
  - larger opening angle
  - $\sigma = 160 \mu m$ at Layer-0

- Very accurate detector mapping!

- Applications:
  - Average $\lambda_1$ measurement
  - Positioning of non-sensitive material (beam pipe, support structures)